



Continental Device India Pvt. Limited

An IATF 16949, ISO9001 and ISO 14001 Certified Company



## NPN SILICON POWER DARLINGTON TRANSISTOR

400 VOLTS 20 AMPERE 175 WATTS

**MJ10005**

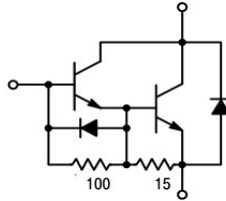
**TO-3**

**Metal Can Package**

**RoHS compliant**



TO-3



### General Description

The MJ10005 Darlington transistor is designed for high-voltage, high-speed, power switching in inductive circuits where fall time is critical. It is particularly suited for line operated switchmode applications

### FEATURES:

1. Fast Turn-Off Times

40 ns Inductive Fall Time @25° C (Typ)

650 ns Inductive Storage Time @ 25° C (Typ)

Operating Temperature Range -65 to +200° C

2. 100° C Performance Specified for: \_

Reversed Biased SOA with Inductive Loads

Switching Times with Inductive Loads

Saturation Voltages

Leakage Currents

### APPLICATION:

1. Switching Regulators

2. Inverters

3. Solenoid and Relay Drivers

4. Motor Controls

5. Deflection Circuits

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**ABSOLUTE MAXIMUM RATINGS (T<sub>a</sub> = 25 °C)**

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V <sub>CEO</sub>	400	Vdc
Collector–Emitter Voltage	V <sub>CEX</sub>	450	Vdc
Collector–Emitter Voltage	V <sub>CEV</sub>	500	Vdc
Emitter Base Voltage	V <sub>EB</sub>	8.0	Vdc
Collector Current — Continuous — Peak (1)	I <sub>C</sub> I <sub>CM</sub>	20 30	Adc
Base Current — Continuous — Peak (1)	I <sub>B</sub> I <sub>BM</sub>	2.5 5.0	Adc
Total Power Dissipation @ T <sub>C</sub> = 25 °C @ T <sub>C</sub> = 100 °C Derate above 25 °C	P <sub>D</sub>	175 100 1.0	Watts W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +200	°C

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R <sub>JC</sub>	1.0	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8 from Case for 5 Seconds	T <sub>L</sub>	275	°C

(1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle ≤ 10%.



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**ELECTRICAL CHARACTERISTICS at  $T_a = 25^\circ\text{C}$**

Characteristic	Symbol	Min	Typ	Max	Unit
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**OFF CHARACTERISTICS**

Collector–Emitter Sustaining Voltage (Table 1) ( $I_C = 250\text{ mA}$ , $I_B = 0$ , $V_{\text{clamp}} = \text{Rated } V_{\text{CEO}}$ )	$V_{\text{CEO(sus)}}$	400	—	—	Vdc
Collector Emitter Sustaining Voltage (Table 1, Figure 12) ( $I_C = 2.0\text{ A}$ , $V_{\text{clamp}} = \text{Rated } V_{\text{CEX}}$ , $T_C = 100^\circ\text{C}$ ) ( $I_C = 10\text{ A}$ , $V_{\text{clamp}} = \text{Rated } V_{\text{CEX}}$ , $T_C = 100^\circ\text{C}$ )	$V_{\text{CEX(sus)}}$	450 325	— —	— —	Vdc
Collector Cutoff Current ( $V_{\text{CEV}} = \text{Rated Value}$ , $V_{\text{BE(off)}} = 1.5\text{ Vdc}$ ) ( $V_{\text{CEV}} = \text{Rated Value}$ , $V_{\text{BE(off)}} = 1.5\text{ Vdc}$ , $T_C = 150^\circ\text{C}$ )	$I_{\text{CEV}}$	— —	— —	0.25 5.0	mAdc
Collector Cutoff Current ( $V_{\text{CE}} = \text{Rated } V_{\text{CEV}}$ , $R_{\text{BE}} = 50\ \Omega$ , $T_C = 100^\circ\text{C}$ )	$I_{\text{CER}}$	—	—	5.0	mAdc
Emitter Cutoff Current ( $V_{\text{EB}} = 2.0\text{ Vdc}$ , $I_C = 0$ )	$I_{\text{EBO}}$	—	—	175	mAdc

**SECOND BREAKDOWN**

Second Breakdown Collector Current with base forward biased	$I_{\text{S/b}}$	See Figure 11			
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**ON CHARACTERISTICS (2)**

DC Current Gain ( $I_C = 5.0\text{ Adc}$ , $V_{\text{CE}} = 5.0\text{ Vdc}$ ) ( $I_C = 10\text{ Adc}$ , $V_{\text{CE}} = 5.0\text{ Vdc}$ )	$h_{\text{FE}}$	50 40	— —	600 400	—
Collector Emitter Saturation Voltage ( $I_C = 10\text{ Adc}$ , $I_B = 400\text{ mAdc}$ ) ( $I_C = 20\text{ Adc}$ , $I_B = 2.0\text{ Adc}$ ) ( $I_C = 10\text{ Adc}$ , $I_B = 400\text{ mAdc}$ , $T_C = 100^\circ\text{C}$ )	$V_{\text{CE(sat)}}$	— — —	— — —	1.9 3.0 2.0	Vdc
Base Emitter Saturation Voltage ( $I_C = 10\text{ Adc}$ , $I_B = 400\text{ mAdc}$ ) ( $I_C = 10\text{ Adc}$ , $I_B = 400\text{ mAdc}$ , $T_C = 100^\circ\text{C}$ )	$V_{\text{BE(sat)}}$	— —	— —	2.5 2.5	Vdc
Diode Forward Voltage (1) ( $I_F = 10\text{ Adc}$ )	$V_f$	—	3.0	5.0	Vdc

**DYNAMIC CHARACTERISTICS**

Small–Signal Current Gain ( $I_C = 1.0\text{ Adc}$ , $V_{\text{CE}} = 10\text{ Vdc}$ , $f_{\text{test}} = 1.0\text{ MHz}$ )	$h_{\text{fe}}$	10	—	—	—
Output Capacitance ( $V_{\text{CB}} = 10\text{ Vdc}$ , $I_E = 0$ , $f_{\text{test}} = 100\text{ kHz}$ )	$C_{\text{ob}}$	100	—	325	pF

**SWITCHING CHARACTERISTICS**

Resistive Load (Table 1)						
Delay Time	$(V_{\text{CC}} = 250\text{ Vdc}$ , $I_C = 10\text{ A}$ , $I_{\text{B1}} = 400\text{ mA}$ , $V_{\text{BE(off)}} = 5.0\text{ Vdc}$ , $t_p = 50\ \mu\text{s}$ , Duty Cycle $\leq 2\%$ ).	$t_d$	—	0.12	0.2	s
Rise Time		$t_r$	—	0.2	0.6	s
Storage Time		$t_s$	—	0.6	1.5	s
Fall Time		$t_f$	—	0.15	0.5	s
Inductive Load Clamped (Table 1)						
Storage Time	$(I_C = 10\text{ A(pk)}$ , $V_{\text{clamp}} = \text{Rated } V_{\text{CEX}}$ , $I_{\text{B1}} = 400\text{ mA}$ , $V_{\text{BE(off)}} = 5.0\text{ Vdc}$ , $T_C = 100^\circ\text{C}$ )	$t_{\text{sv}}$	—	1.0	2.5	s
Crossover Time		$t_c$	—	0.4	1.5	s
Storage Time	$(I_C = 10\text{ A(pk)}$ , $V_{\text{clamp}} = \text{Rated } V_{\text{CEX}}$ , $I_{\text{B1}} = 400\text{ mA}$ , $V_{\text{BE(off)}} = 5.0\text{ Vdc}$ , $T_C = 25^\circ\text{C}$ )	$t_{\text{sv}}$	—	0.65	—	s
Crossover Time		$t_c$	—	0.2	—	s

- (1) The internal Collector–to–Emitter diode can eliminate the need for an external diode to clamp inductive loads.  
Tests have shown that the Forward Recovery Voltage ( $V_f$ ) of this diode is comparable to that of typical fast recovery rectifiers.
- (2) Pulse Test:  $\text{PW} = 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

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### Typical Characteristic Curves

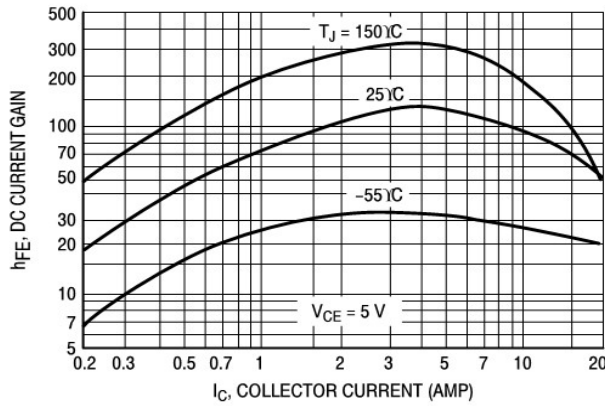


Figure 1. DC Current Gain

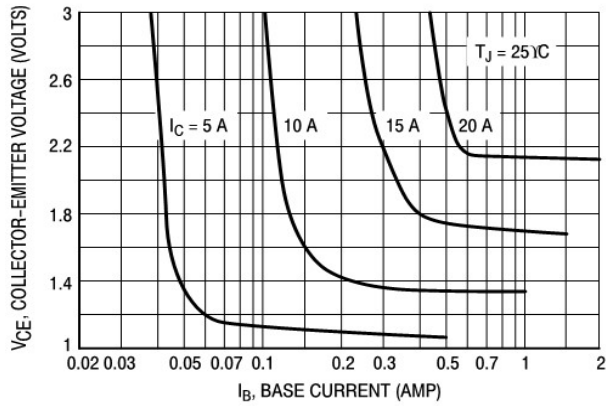


Figure 2. Collector Saturation Region

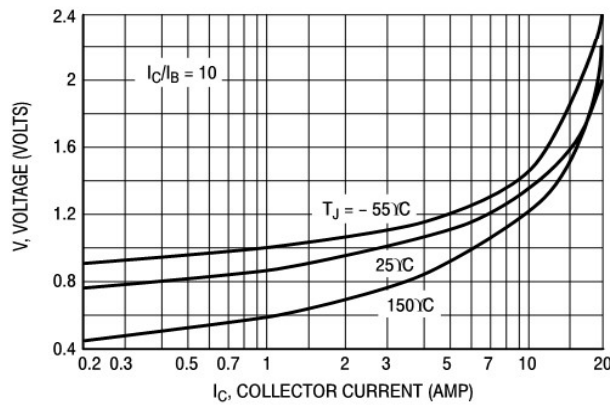


Figure 3. Collector-Emitter Saturation Voltage

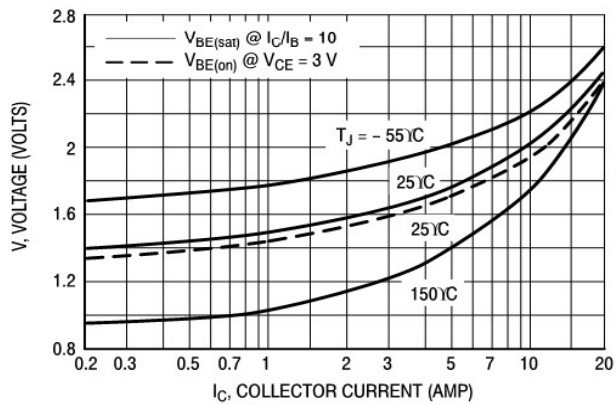


Figure 4. Base-Emitter Voltage

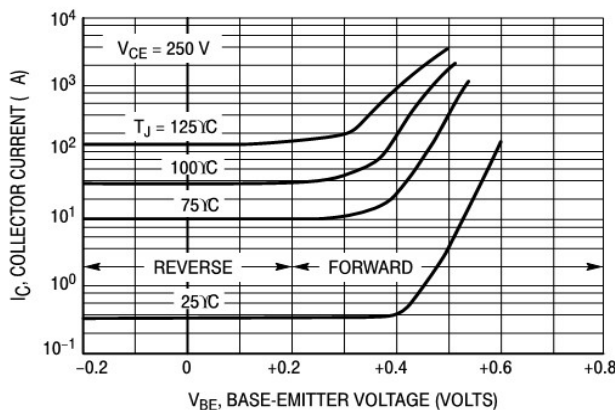


Figure 5. Collector Cutoff Region

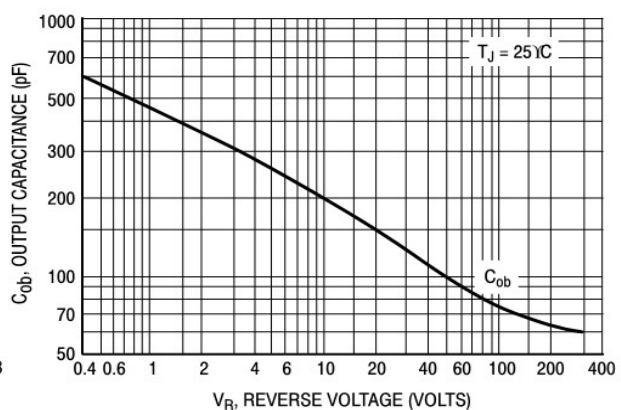
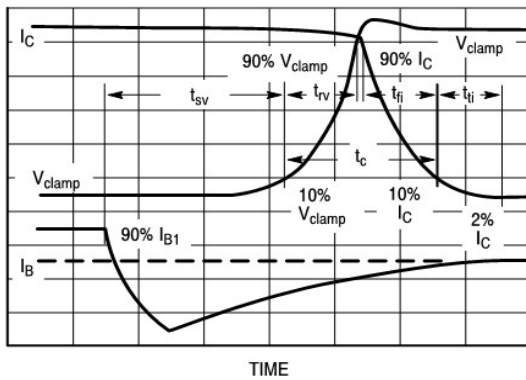


Figure 6. Output Capacitance

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**Table 1. Test Conditions for Dynamic Performance**

	$V_{CE0(sus)}$	$V_{CEX(sus)}$ AND INDUCTIVE SWITCHING	RESISTIVE SWITCHING
INPUT CONDITIONS	<p>PW Varied to Attain <math>I_C = 250</math> mA</p>	<p><b>INDUCTIVE TEST CIRCUIT</b></p>	
CIRCUIT VALUES	$L_{coil} = 10$ mH, $V_{CC} = 10$ V $R_{coil} = 0.7$ $V_{clamp} = V_{CE0(sus)}$	$L_{coil} = 180$ H $R_{coil} = 0.05$ $V_{CC} = 20$ V $V_{clamp} = \text{Rated } V_{CEX} \text{ Value}$	$V_{CC} = 250$ V $R_L = 25$ Pulse Width = 50 $\mu$ s
TEST CIRCUITS	<p><b>INDUCTIVE TEST CIRCUIT</b></p>	<p><b>OUTPUT WAVEFORMS</b></p> <p><math>t_1</math> Adjusted to Obtain <math>I_C</math></p> $t_1 \approx \frac{L_{coil} (C_{pk})}{V_{CC}}$ $t_2 \approx \frac{L_{coil} (C_{pk})}{V_{Clamp}}$ <p>Test Equipment Scope — Tektronix 475 or Equivalent</p>	<p><b>RESISTIVE TEST CIRCUIT</b></p>



**Figure 7. Inductive Switching Measurements**

## Typical Characteristic Curves

### RESISTIVE SWITCHING PERFORMANCE

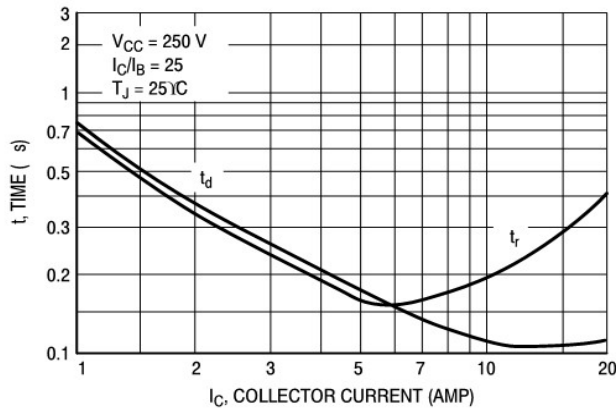


Figure 8. Turn-On Time

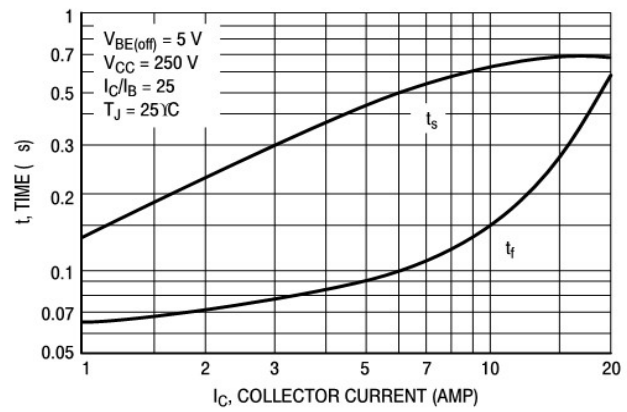


Figure 9. Turn-Off Time

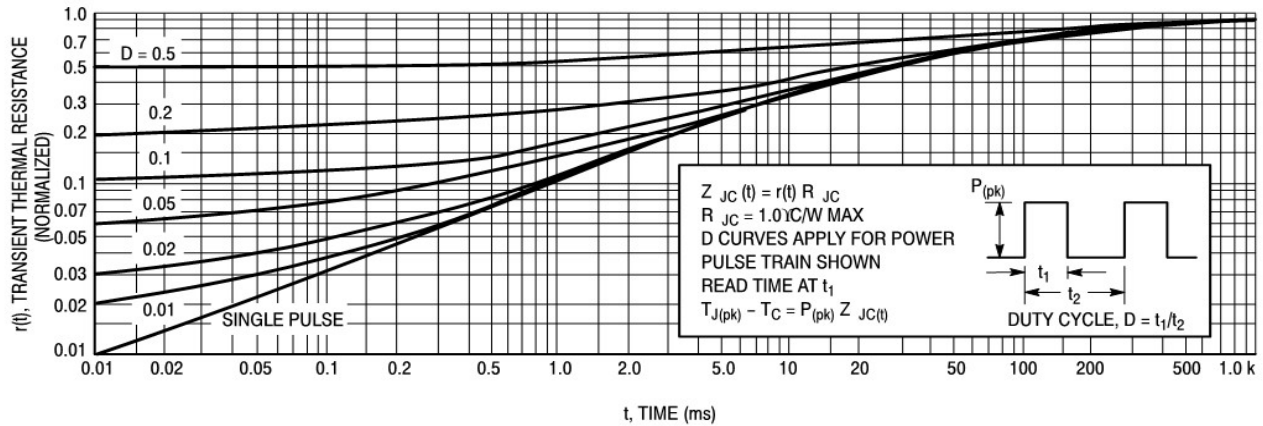


Figure 10. Thermal Response

### Typical Characteristic Curves

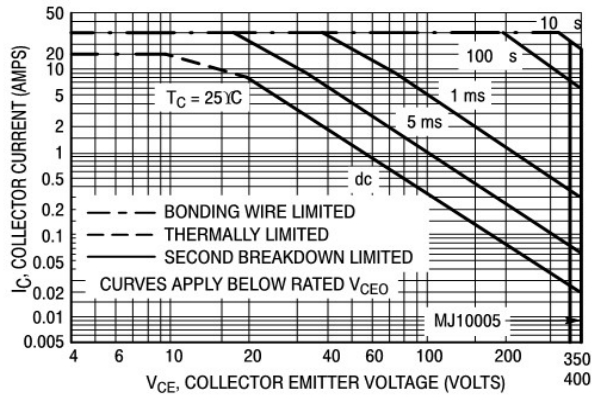


Figure 11. Forward Bias Safe Operating Area

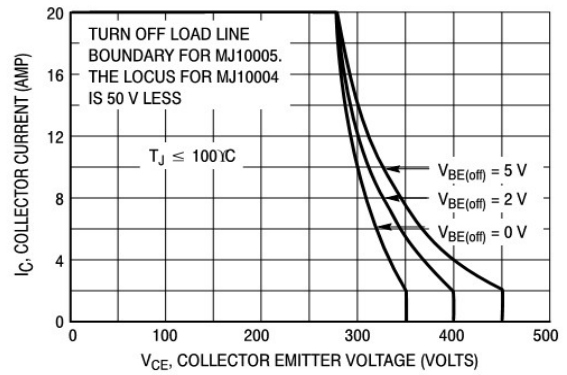


Figure 12. Reverse Bias Switching Safe Operating Area

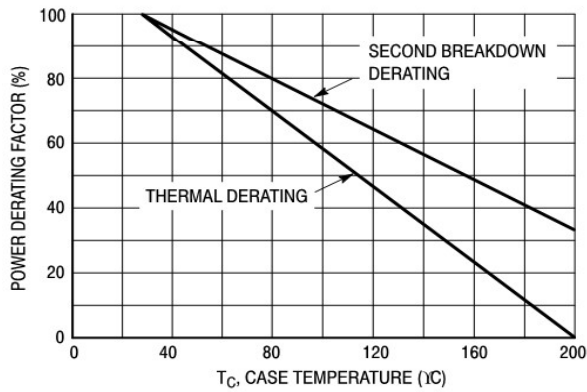
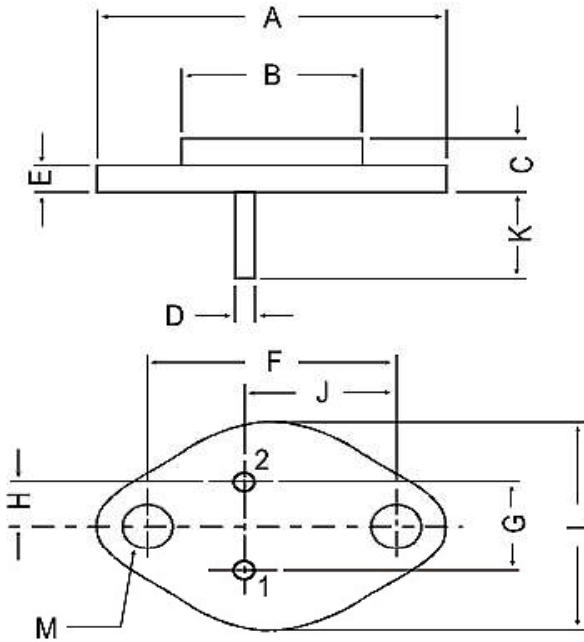


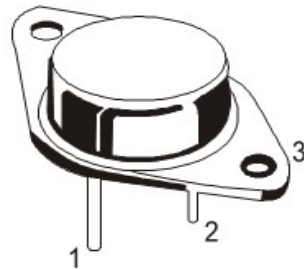
Figure 13. Power Derating

### Package Details



All dimensions in mm.

DIM	MIN.	MAX.
A	—	39.37
B	—	22.22
C	6.35	8.50
D	0.96	1.09
E	—	1.77
F	29.90	30.40
G	10.69	11.18
H	5.20	5.72
J	16.64	17.15
K	11.15	12.25
L	—	26.67
M	3.84	4.19



#### PIN CONFIGURATION

1. BASE
2. EMITTER
3. COLLECTOR

### Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-3	100 pcs/pkt	1.3 kg/100 pcs	12.5" x 8" x 1.8"	0.1K	17" x 11.5" x 21"	2K	27.5 kgs





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### Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- Temperature 5 °C to 30 °C
- Humidity between 40 to 70 %RH
- Air should be clean.
- Avoid harmful gas or dust.
- Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- Avoid rapid change of temperature.
- Avoid condensation.
- Mechanical stress such as vibration and impact shall be avoided.
- The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

### Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

### Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level		
Level	Time	Condition
1	Unlimited	≤30 °C / 85% RH
2	1 Year	≤30 °C / 60% RH
2a	4 Weeks	≤30 °C / 60% RH
3	168 Hours	≤30 °C / 60% RH
4	72 Hours	≤30 °C / 60% RH
5	48 Hours	≤30 °C / 60% RH
5a	24 Hours	≤30 °C / 60% RH
6	Time on Label(TOL)	≤30 °C / 60% RH

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## Customer Notes

### Component Disposal Instructions

1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

### Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information.

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